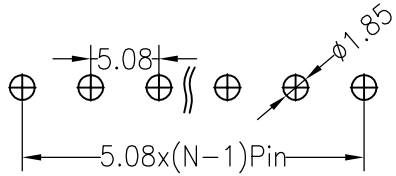
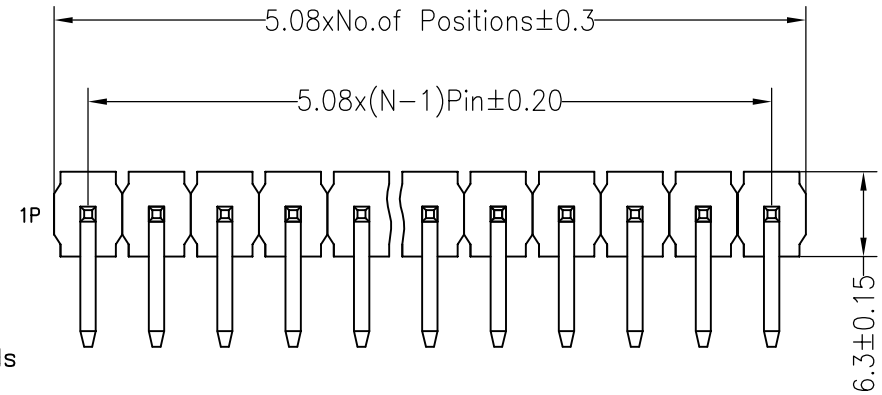
HSF RoHS

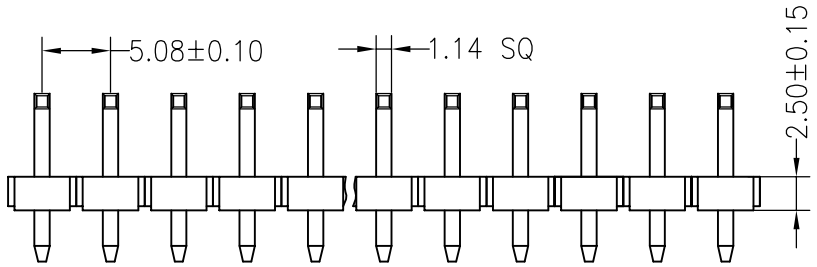
SPECIFICATIONS
Rated Current:7.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°C to +105°C

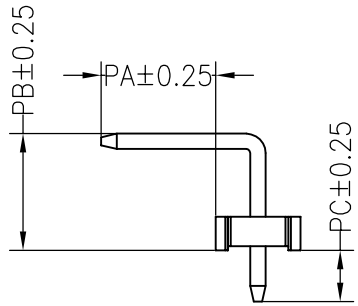
Contact Material:Brass
Contact Plating:Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: LCP
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)









Ordering Information

1125 11XX F N XX R XXX X01

- 11XX: No.of Pins Per Row 1x20
- F: Insulator Material Option
  - A=BK−PBT
  - B=BK−PA66
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- N XX: Contact Plating
  - G0:Gold Flash
  - S0:Gold Flash/Tin
  - SN:Tin
  - SM:Matte−Tin
- R XXX: Pin Length
- X01: Packing
  - 0=PE Bag
  - A=Tray
  - T=Tube

Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	8.00	5.00	3.50	18.8
Alternate				

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.11	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.04.11
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	112511XXXFNXXRXXXX01
TITLE:	5.08PH 1xNpin H2.5mm 90°